504668405 12/03/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4715127

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

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XIANBO HUANG	11/24/2017
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KAI XIONG	11/24/2017
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KAIJIN MAI	11/24/2017
XUETENG DONG	11/24/2017

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	15578252	

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PATENT 504668405 REEL: 044282 FRAME: 0136

ATTORNEY DOCKET NUMBER:	74834-US-PA-PCT	
NAME OF SUBMITTER:	BELINDA LEE	
SIGNATURE:	/Belinda Lee/	
DATE SIGNED:	12/03/2017	
Total Attachments: 4		
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PATENT REEL: 044282 FRAME: 0137

□ Declaration Submitted With Initial Filing				
OR				
☐ Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)				
(Title of the Invention) BIODEGRADABLE POLYESTER COMPOSITION				
As a below named inventor (hereinafter designated as the undersigned), I hereby declare that: This declaration is directed to:				
The attached application, OR				
United States Application Number or PCT International application number PCT/CN2017/074667 Filed on 2017/2/24				
The above-identified application was made or authorized to be made by me.				
I believe I am the original inventor or an original joint inventor of a claimed invention in the application.				

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS 1. YANG, Hongmei

of No.461 Huangshi East Road, Yuexiu District Guangzhou, Guangdong 510075, China

hereinaster referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

-2-

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